

# 8A, 400V - 1000V Surface Mount Glass Passivated Rectifier

#### **FEATURES**

- Low forward voltage drop
- Ideal for automated placement
- High surge current capability
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

#### **APPLICATIONS**

- Switching mode power supply (SMPS)
- Adapters
- Lighting application
- Converter

ME	CH	ΔΝ	IC/		DΔ	TA
	$\mathbf{v}$			~-		

- Case: DO-214AB (SMC)
- Molding compound meets UL 94V-0 flammability rating
- Part no. with suffix "H" means AEC-Q101 qualified
- Packing code with suffix "G" means green compound (halogen-free)
- Moisture sensitivity level: level 1, per J-STD-020
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 0.27 g (approximately)

KEY PARAMETERS						
PARAMETER	VALUE	UNIT				
I <sub>F(AV)</sub>	8	Α				
$V_{RRM}$	400 - 1000	V				
I <sub>FSM</sub>	200	Α				
T <sub>J MAX</sub>	150	°C				
Package	e DO-214AB (SMC)					
Configuration	Single die					





**DO-214AB (SMC)** 

ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C unless otherwise noted)							
PARAMETER		SYMBOL	S8GC	S8JC	S8KC	S8MC	UNIT
Marking code on the device			S8GC	S8JC	S8KC	S8MC	
Repetitive peak reverse voltage		$V_{RRM}$	400	600	800	1000	V
Reverse voltage, total rms value		$V_{R(RMS)}$	280	420	560	700	V
Maximum DC blocking voltage		$V_{DC}$	400	600	800	1000	V
Forward current		I <sub>F(AV)</sub>	8			Α	
Surge peak forward current, 8.3 ms $T_J = 25^{\circ}$ C		1	200		Α		
single half sine-wave superimposed on rated load per diode	T <sub>J</sub> =125°C	I <sub>FSM</sub>		17	70		Α
Surge peak forward current, 1.0 ms	Surge peak forward current, 1.0 ms T <sub>1</sub> =25°C			60	00		Α
single half sine-wave superimposed on rated load per diode $T_J = 125^{\circ}C$		I <sub>FSM</sub>		33	38		Α
Junction temperature		TJ	- 55 to +150		°C		
Storage temperature		T <sub>STG</sub>	- 55 to +150		°C		





THERMAL PERFORMANCE						
PARAMETER	SYMBOL	LIMIT	UNIT			
Junction-to-lead thermal resistance per diode	$R_{\Theta JL}$	12.5	°C/W			
Junction-to-ambient thermal resistance per diode	$R_{\Theta JA}$	44.0	°C/W			

ELECTRICAL SPECIFICATIONS (T <sub>A</sub> = 25°C unless otherwise noted)							
PARAMETER	CONDITIONS	SYMBOL	TYP.	MAX.	UNIT		
Forward voltage per diode (1)	I <sub>F</sub> = 8A, T <sub>J</sub> = 25°C	$V_{F}$	-	0.985	V		
Reverse current @ rated V <sub>R</sub> per diode <sup>(2)</sup>	T <sub>J</sub> = 25°C			10	μA		
Reverse current & rated v <sub>R</sub> per diode			-	250	μA		
Junction capacitance	1 MHz, V <sub>R</sub> =4.0V	CJ	48	-	pF		

#### Notes:

- 1. Pulse test with PW=0.3 ms
- 2. Pulse test with PW=30 ms

ORDERING INFORMATION						
PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX	PACKAGE	PACKING	
		R7		SMC	850 / 7" Plastic reel	
		R6		SMC	3,000 / 13" Paper reel	
S8xC (Note 1)	Н	M6	G	SMC	3,000 / 13" Plastic reel	
(14016-1)		V7		Matrix SMC	850 / 7" Plastic reel	
		V6		Matrix SMC	3,000 / 13" Plastic reel	

### Note:

1. "x" defines voltage from 400V (S8GC) to 1000V (S8MC)

EXAMPLE						
EXAMPLE P/N	PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION	
S8GCHR7G	S8GC	Н	R7	G	AEC-Q101 qualified Green compound	



#### **CHARACTERISTICS CURVES**

(T<sub>A</sub> = 25°C unless otherwise noted)

**Fig.1 Forward Current Derating Curve** 

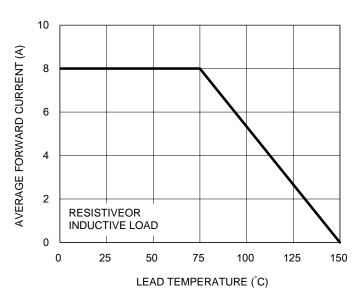


Fig.2 Maximum Non-repetitive Forward Surge Current

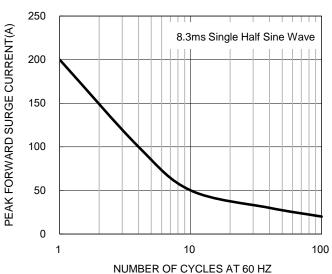


Fig.3 Typical Reverse Characteristics

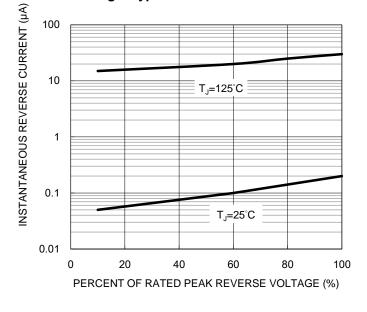
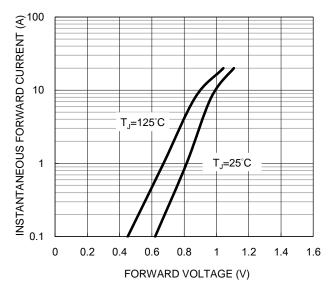


Fig.4 Typical Forward Characteristics

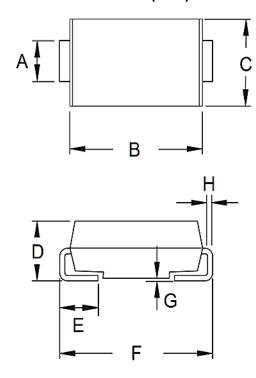


3



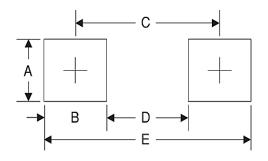
## **PACKAGE OUTLINE DIMENSIONS**

### DO-214AB (SMC)



DIM.	Unit	(mm)	Unit (inch)		
DIIVI.	Min.	Max.	Min.	Max.	
Α	2.90	3.20	0.114	0.126	
В	6.60	7.11	0.260	0.280	
С	5.59	6.22	0.220	0.245	
D	2.00	2.62	0.079	0.103	
E	1.00	1.60	0.039	0.063	
F	7.75	8.13	0.305	0.320	
G	0.10	0.20	0.004	0.008	
Н	0.15	0.31	0.006	0.012	

### **SUGGESTED PAD LAYOUT**



Symbol	Unit (mm)	Unit (inch)
А	3.30	0.130
В	2.50	0.098
С	6.80	0.268
D	4.40	0.173
E	9.40	0.370

### **MARKING DIAGRAM**



P/N =Marking Code G =Green Compound

=Date Code ΥW

F =Factory Code





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